

## Current Mode PWM Controller

### FEATURES

- Optimized for Off-line and DC to DC Converters
- Low Start Up Current (<0.5mA)
- Trimmed Oscillator Discharge Current
- Automatic Feed Forward Compensation
- Pulse-by-Pulse Current Limiting
- Enhanced Load Response Characteristics
- Under-Voltage Lockout With Hysteresis
- Double Pulse Suppression
- High Current Totem Pole Output
- Internally Trimmed Bandgap Reference
- 500kHz Operation
- Low Ro Error Amp

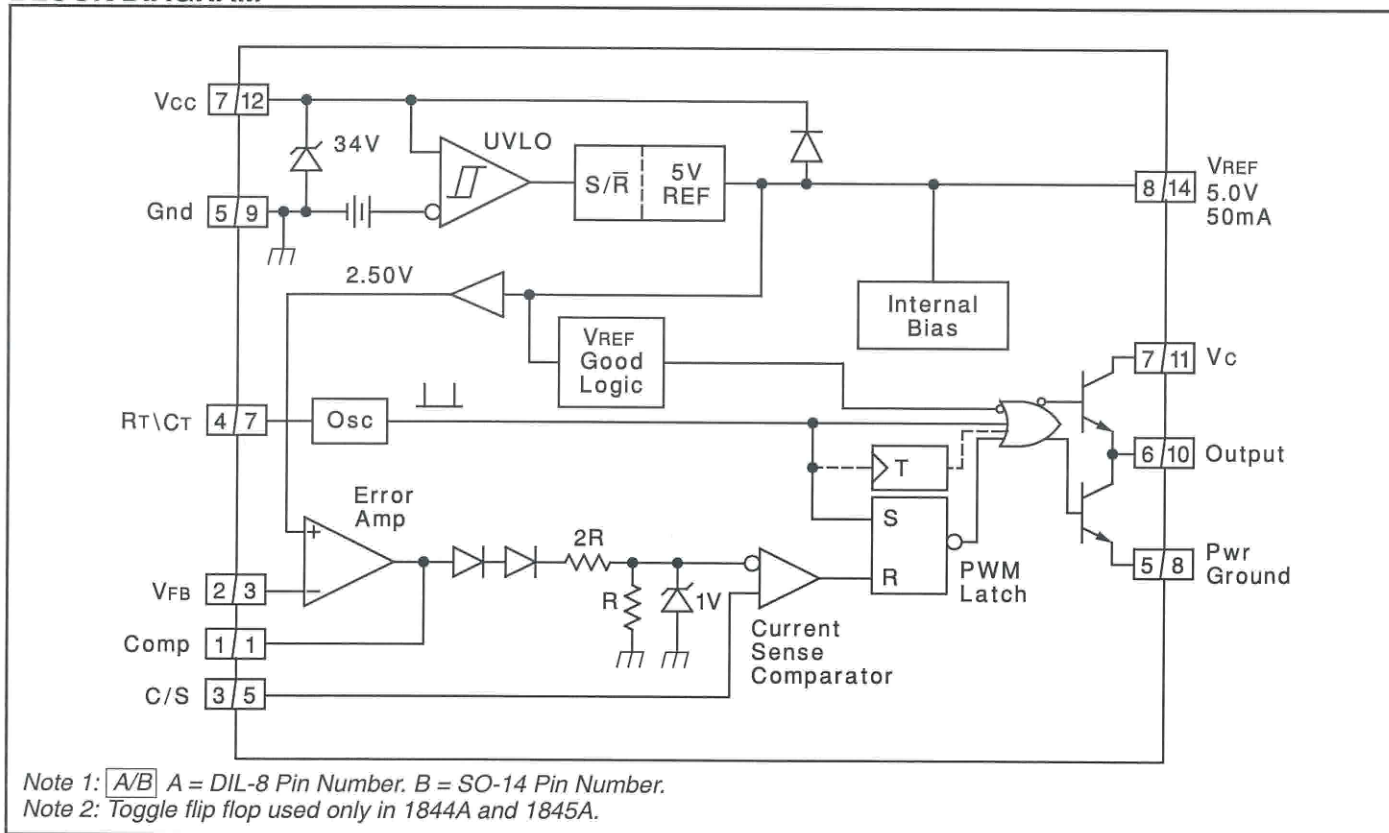
### DESCRIPTION

The UC1842A/3A/4A/5A family of control ICs is a pin for pin compatible improved version of the UC3842/3/4/5 family. Providing the necessary features to control current mode switched mode power supplies, this family has the following improved features. Start up current is guaranteed to be less than 0.5mA. Oscillator discharge is trimmed to 8.3mA. During under voltage lockout, the output stage can sink at least 10mA at less than 1.2V for Vcc over 5V.

The difference between members of this family are shown in the table below.

| Part #  | UVLO On | UVLO Off | Maximum Duty Cycle |
|---------|---------|----------|--------------------|
| UC1842A | 16.0V   | 10.0V    | <100%              |
| UC1843A | 8.5V    | 7.9V     | <100%              |
| UC1844A | 16.0V   | 10.0V    | <50%               |
| UC1845A | 8.5V    | 7.9V     | <50%               |

### BLOCK DIAGRAM



## CONNECTION DIAGRAMS

UC1842A/3A/4A/5A

UC2842A/3A/4A/5A

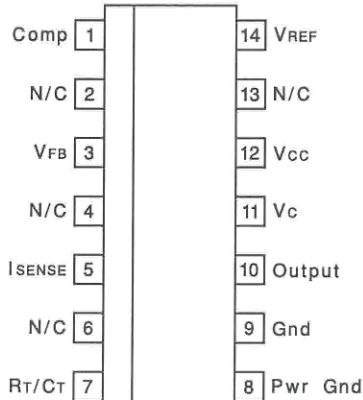
UC3842A/3A/4A/5A

### ABSOLUTE MAXIMUM RATINGS (Note 1)

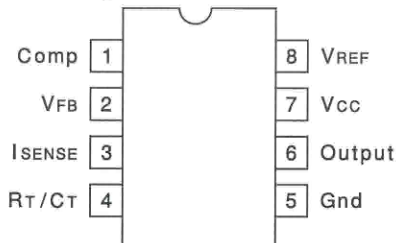
Supply Voltage (Low Impedance Source) ..... 30V  
 Supply Voltage (I<sub>CC</sub> mA) ..... Self Limiting  
 Output Current ..... ±1A  
 Output Energy (Capacitive Load) ..... 5μJ  
 Analog Inputs (Pins 2, 3) ..... -0.3V to +6.3V  
 Max negative voltage all pins ..... -0.3V  
 For 14 and 20 pin packages ..... (V<sub>C</sub> - V<sub>CC</sub>) > -0.3V  
 Error Amp Output Sink Current ..... 10mA  
 Power Dissipation at T<sub>A</sub> ≤ 25°C (DIL-8) ..... 1W  
 Storage Temperature Range ..... -65°C to +150°C  
 Junction Temperature Range ..... -55°C to +150°C  
 Lead Temperature (Soldering, 10 Seconds) ..... 300°C

*Note 1. All voltages are with respect to Ground, Pin 5. Currents are positive into, negative out of the specified terminal. Consult Packaging Section of Databook for thermal limitations and considerations of packages. Pin numbers refer to DIL package only. The GND pins and the PGND pins must be connected to each other with short thick traces.*

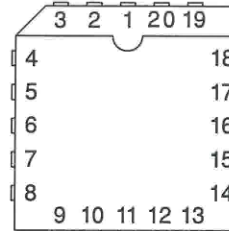
### SOIC-14 (TOP VIEW) D Package



### DIL-8, SOIC-8 (TOP VIEW) J or N, D8 Package

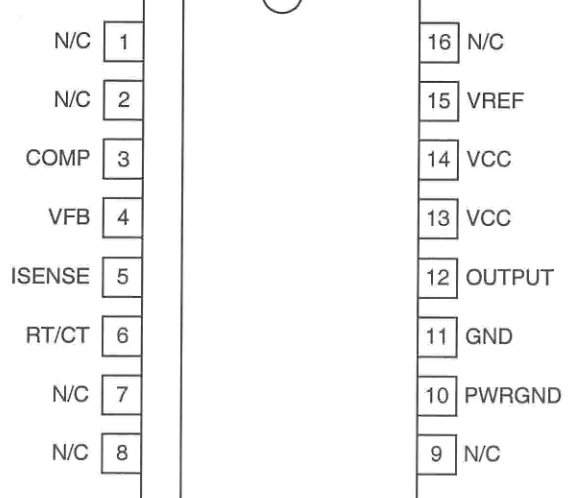


### PLCC-20, LCC-20 (TOP VIEW) Q, L Packages



| PACKAGE PIN FUNCTION |     |
|----------------------|-----|
| FUNCTION             | PIN |
| N/C                  | 1   |
| Comp                 | 2   |
| N/C                  | 3-4 |
| VFB                  | 5   |
| N/C                  | 6   |
| ISENSE               | 7   |
| N/C                  | 8-9 |
| RT/CT                | 10  |
| N/C                  | 11  |
| Pwr Gnd              | 12  |
| Gnd                  | 13  |
| N/C                  | 14  |
| Output               | 15  |
| N/C                  | 16  |
| V <sub>C</sub>       | 17  |
| V <sub>CC</sub>      | 18  |
| N/C                  | 19  |
| VREF                 | 20  |

### SOIC-WIDE16 (TOP VIEW) DW Package



## THERMAL CHARACTERISTICS

Over operating free-air temperature range (unless otherwise noted)

| PACKAGE      |     | $\theta_{JC}$     | $\theta_{JA}$           |
|--------------|-----|-------------------|-------------------------|
| DIL - 8      | J   | 28 <sup>(1)</sup> | 125 - 160               |
|              | N   | 25                | 110 <sup>(2)</sup>      |
| SOIC - 8     | D8  | 42                | 84 - 160 <sup>(2)</sup> |
| SOIC - 14    | D14 | 35                | 50 - 120 <sup>(2)</sup> |
| CFP - 14     | W   | 5.49 °C/W         | 175.4 °C/W              |
| PLCC - 20    | Q   | 34                | 43 - 75 <sup>(2)</sup>  |
| SOIC Wide 16 | DW  | 27                | 50 - 100 <sup>(2)</sup> |
| LLC - 20     | L   | 20 <sup>(3)</sup> | 70 - 80                 |

(1)  $\theta_{JC}$  data values stated were derived from MIL-STD-1835B.

(2) Specified  $\theta_{JA}$  (junction to ambient) is for devices mounted to 5 in<sup>2</sup> FR4 PC board with one ounce copper where noted. When resistance range is given, lower values are for 5 in<sup>2</sup>. Test PWB was 0.062 in thick and typically used 0.635-mm trace widths for power packages and 1.3-mm trace widths for non-power packages with 100 x 100-mil probe land area at the end of each trace.

(3)  $\theta_{JC}$  data values stated were derived from MIL-STD-1835B. MIL-STD-1835B states that "The baseline values shown are worse case (mean+2s) for a 60 x 60 mil microcircuit device silicon die and applicable for devices with die sizes up to 144000 square mils. For device sizes greater than 14400 square mils use the following values; dual-in-line, 11°C/W; flat pack, 10°C/W; pin grid array, 10°C/W".

## DISSIPATION RATINGS

| PACKAGE | $T_A \leq 25^\circ\text{C}$<br>POWER RATING <sub>c</sub> | DERATING<br>FACTOR ABOVE<br>$T_A \leq 25^\circ\text{C}$ | $T_A \leq 70^\circ\text{C}$<br>POWER RATING | $T_A \leq 80^\circ\text{C}$<br>POWER RATING | $T_A \leq 125^\circ\text{C}$<br>POWER RATING |
|---------|----------------------------------------------------------|---------------------------------------------------------|---------------------------------------------|---------------------------------------------|----------------------------------------------|
| W       | 700 mW                                                   | 5.5 mW/°C                                               | 452 mW                                      | 370 mW                                      | 150 mW                                       |

**ELECTRICAL CHARACTERISTICS** Unless otherwise stated, these specifications apply for  $-55^{\circ}\text{C} \leq T_A \leq 125^{\circ}\text{C}$  for the UC184xA;  $-40^{\circ}\text{C} \leq T_A \leq 125^{\circ}\text{C}$  for the UC284xAQ;  $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$  for the UC284xA;  $0 \leq T_A \leq 70^{\circ}\text{C}$  for the UC384xA;  $V_{CC} = 15\text{V}$  (Note 5);  $R_T = 10\text{k}\Omega$ ;  $C_T = 3.3\text{nF}$ ;  $T_A = T_J$ ; Pin numbers refer to DIL-8.

| PARAMETER              | TEST CONDITIONS                        | UC184xA\UC284xA |      |      | UC384xA |      |      | UNITS |
|------------------------|----------------------------------------|-----------------|------|------|---------|------|------|-------|
|                        |                                        | MIN.            | TYP. | MAX. | MIN.    | TYP. | MAX. |       |
| Reference Section      |                                        |                 |      |      |         |      |      |       |
| Output Voltage         | TJ = 25°C, IO = 1mA                    | 4.95            | 5.00 | 5.05 | 4.90    | 5.00 | 5.10 | V     |
| Line Regulation        | 12 ≤ VIN 25V                           |                 | 6    | 20   |         | 6    | 20   | mV    |
| Load Regulation        | 1 ≤ IO ≤ 20mA                          |                 | 6    | 25   |         | 6    | 25   | mV    |
| Temp. Stability        | (Note 2, Note 7)                       |                 | 0.2  | 0.4  |         | 0.2  | 0.4  | mV/°C |
| Total Output Variation | Line, Load, Temp.                      | 4.9             |      | 5.1  | 4.82    |      | 5.18 | V     |
| Output Noise Voltage   | 10Hz ≤ f ≤ 10kHz<br>TJ = 25°C (Note 2) |                 | 50   |      |         | 50   |      | μV    |
| Long Term Stability    | TA = 125°C, 1000Hrs. (Note 2)          |                 | 5    | 25   |         | 5    | 25   | mV    |
| Output Short Circuit   |                                        | -30             | -100 | -180 | -30     | -100 | -180 | mA    |
| Oscillator Section     |                                        |                 |      |      |         |      |      |       |
| Initial Accuracy       | TJ = 25°C (Note 6)                     | 47              | 52   | 57   | 47      | 52   | 57   | kHz   |
| Voltage Stability      | 12 ≤ VCC ≤ 25V                         |                 | 0.2  | 1    |         | 0.2  | 1    | %     |
| Temp. Stability        | TMIN ≤ TA ≤ TMAX (Note 2)              |                 | 5    |      |         | 5    |      | %     |
| Amplitude              | VPIN 4 peak to peak (Note 2)           |                 | 1.7  |      |         | 1.7  |      | V     |
| Discharge Current      | TJ = 25°C, VPIN 4 = 2V (Note 8)        | 7.8             | 8.3  | 8.8  | 7.8     | 8.3  | 8.8  | mA    |
|                        | VPIN 4 = 2V (Note 8)                   | 7.5             |      | 8.8  | 7.6     |      | 8.8  | mA    |
| Error Amp Section      |                                        |                 |      |      |         |      |      |       |
| Input Voltage          | VPIN 1 = 2.5V                          | 2.45            | 2.50 | 2.55 | 2.42    | 2.50 | 2.58 | V     |
| Input Bias Current     |                                        |                 | -0.3 | -1   |         | -0.3 | -2   | μA    |
| AVOL                   | 2 ≤ VO ≤ 4V                            | 65              | 90   |      | 65      | 90   |      | dB    |
| Unity Gain Bandwidth   | TJ = 25°C (Note 2)                     | 0.7             | 1    |      | 0.7     | 1    |      | MHz   |
| PSRR                   | 12 ≤ VCC ≤ 25V                         | 60              | 70   |      | 60      | 70   |      | dB    |
| Output Sink Current    | VPIN 2 = 2.7V, VPIN 1 = 1.1V           | 2               | 6    |      | 2       | 6    |      | mA    |
| Output Source Current  | VPIN 2 = 2.3V, VPIN 1 = 5V             | -0.5            | -0.8 |      | -0.5    | -0.8 |      | mA    |
| VOUT High              | VPIN 2 = 2.3V, RL = 15k to ground      | 5               | 6    |      | 5       | 6    |      | V     |
| VOUT Low               | VPIN 2 = 2.7V, RL = 15k to Pin 8       |                 | 0.7  | 1.1  |         | 0.7  | 1.1  | V     |
| Current Sense Section  |                                        |                 |      |      |         |      |      |       |
| Gain                   | (Note 3, Note 4)                       | 2.85            | 3    | 3.15 | 2.85    | 3    | 3.15 | V/V   |
| Maximum Input Signal   | VPIN 1 = 5V (Note 3)                   | 0.9             | 1    | 1.1  | 0.9     | 1    | 1.1  | V     |
| PSRR                   | 12 ≤ VCC ≤ 25V (Note 3)                |                 | 70   |      |         | 70   |      | dB    |
| Input Bias Current     |                                        |                 | -2   | -10  |         | -2   | -10  | μA    |
| Delay to Output        | VPIN 3 = 0 to 2V (Note 2)              |                 | 150  | 300  |         | 150  | 300  | ns    |
| Output Section         |                                        |                 |      |      |         |      |      |       |
| Output Low Level       | ISINK = 20mA                           |                 | 0.1  | 0.4  |         | 0.1  | 0.4  | V     |
|                        | ISINK = 200mA                          |                 | 1.5  | 2.2  |         | 1.5  | 2.2  | V     |
| Output High Level      | ISOURCE = 20mA                         | 13              | 13.5 |      | 13      | 13.5 |      | V     |
|                        | ISOURCE = 200mA                        | 12              | 13.5 |      | 12      | 13.5 |      | V     |
| Rise Time              | TJ = 25°C, CL = 1nF (Note 2)           |                 | 50   | 150  |         | 50   | 150  | ns    |
| Fall Time              | TJ = 25°C, CL = 1nF (Note 2)           |                 | 50   | 150  |         | 50   | 150  | ns    |
| UVLO Saturation        | VCC = 5V, ISINK = 10mA                 |                 | 0.7  | 1.2  |         | 0.7  | 1.2  | V     |

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| PARAMETER                            | TEST CONDITIONS                              | UC184xA\UC284xA |      |      | UC384xA |      |      | UNITS |
|--------------------------------------|----------------------------------------------|-----------------|------|------|---------|------|------|-------|
|                                      |                                              | MIN.            | TYP. | MAX. | MIN.    | TYP. | MAX. |       |
| Under-Voltage Lockout Section        |                                              |                 |      |      |         |      |      |       |
| Start Threshold                      | x842A/4A                                     | 15              | 16   | 17   | 14.5    | 16   | 17.5 | V     |
|                                      | x843A/5A                                     | 7.8             | 8.4  | 9.0  | 7.8     | 8.4  | 9.0  | V     |
| Min. Operation Voltage After Turn On | x842A/4A                                     | 9               | 10   | 11   | 8.5     | 10   | 11.5 | V     |
|                                      | x843A/5A                                     | 7.0             | 7.6  | 8.2  | 7.0     | 7.6  | 8.2  | V     |
| PWM Section                          |                                              |                 |      |      |         |      |      |       |
| Maximum Duty Cycle                   | x842A/3A                                     | 94              | 96   | 100  | 94      | 96   | 100  | %     |
|                                      | x844A/5A                                     | 47              | 48   | 50   | 47      | 48   | 50   | %     |
| Minimum Duty Cycle                   |                                              |                 |      | 0    |         |      | 0    | %     |
| Total Standby Current                |                                              |                 |      |      |         |      |      |       |
| Start-Up Current                     |                                              |                 | 0.3  | 0.5  |         | 0.3  | 0.5  | mA    |
| Operating Supply Current             | V <sub>PIN 2</sub> = V <sub>PIN 3</sub> = 0V |                 | 11   | 17   |         | 11   | 17   | mA    |
| V <sub>CC</sub> Zener Voltage        | I <sub>CC</sub> = 25mA                       | 30              | 34   |      | 30      | 34   |      | V     |

**Note 2:** Ensured by design, but not 100% production tested.

**Note 3:** Parameter measured at trip point of latch with  $V_{PIN2} = 0$ .

**Note 4:** Gain defined as:  $A = \frac{\Delta V_{PIN1}}{\Delta V_{PIN3}}$ ;  $0 \leq V_{PIN3} \leq 0.8\text{V}$ .

**Note 5:** Adjust V<sub>CC</sub> above the start threshold before setting at 15V.

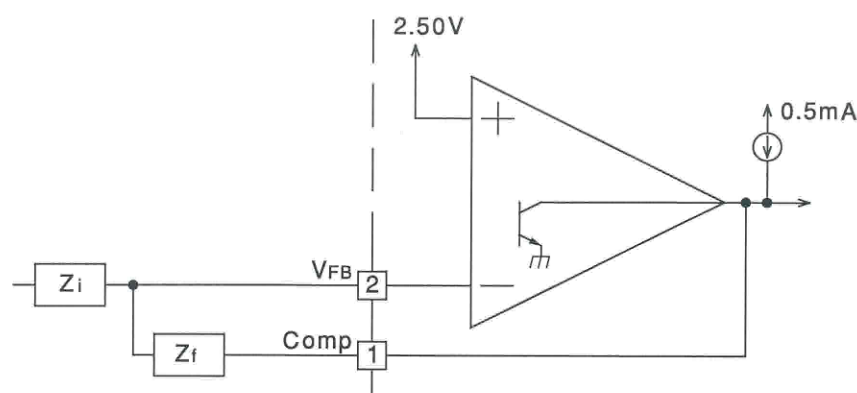
**Note 6:** Output frequency equals oscillator frequency for the UC1842A and UC1843A. Output frequency is one half oscillator frequency for the UC1844A and UC1845A.

**Note 7:** "Temperature stability, sometimes referred to as average temperature coefficient, is described by the equation:

$$\text{Temp Stability} = \frac{V_{REF}(\text{max}) - V_{REF}(\text{min})}{T_J(\text{max}) - T_J(\text{min})}. V_{REF}(\text{max}) \text{ and } V_{REF}(\text{min}) \text{ are the maximum \& minimum reference voltage measured over the appropriate temperature range. Note that the extremes in voltage do not necessarily occur at the extremes in temperature.}$$

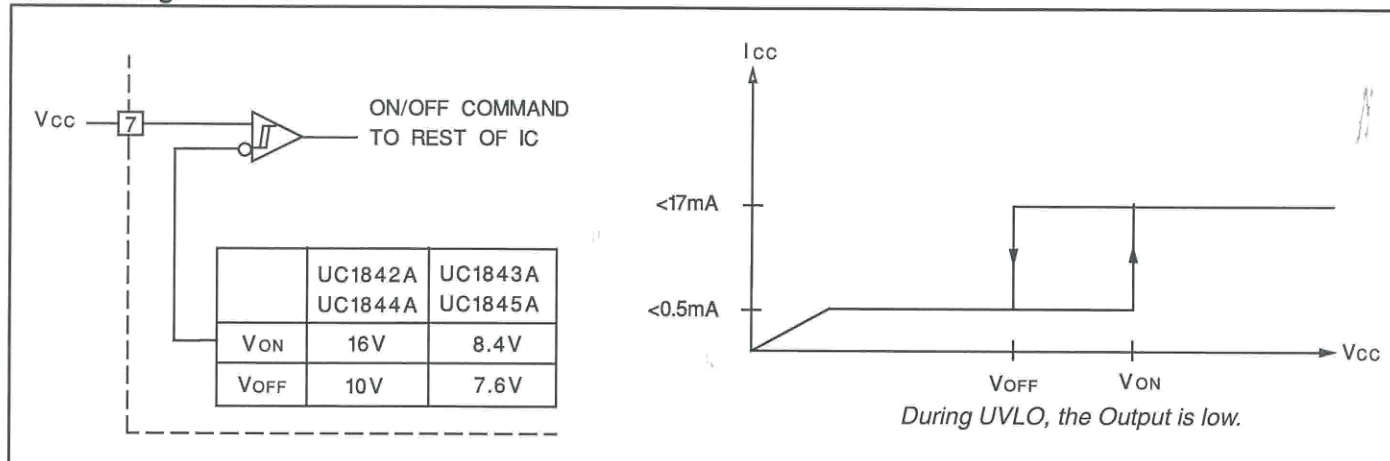
**Note 8:** This parameter is measured with  $R_T = 10\text{k}\Omega$  to V<sub>REF</sub>. This contributes approximately 300μA of current to the measurement. The total current flowing into the R<sub>T</sub>/C pin will be approximately 300μA higher than the measured value.

## Error Amp Configuration

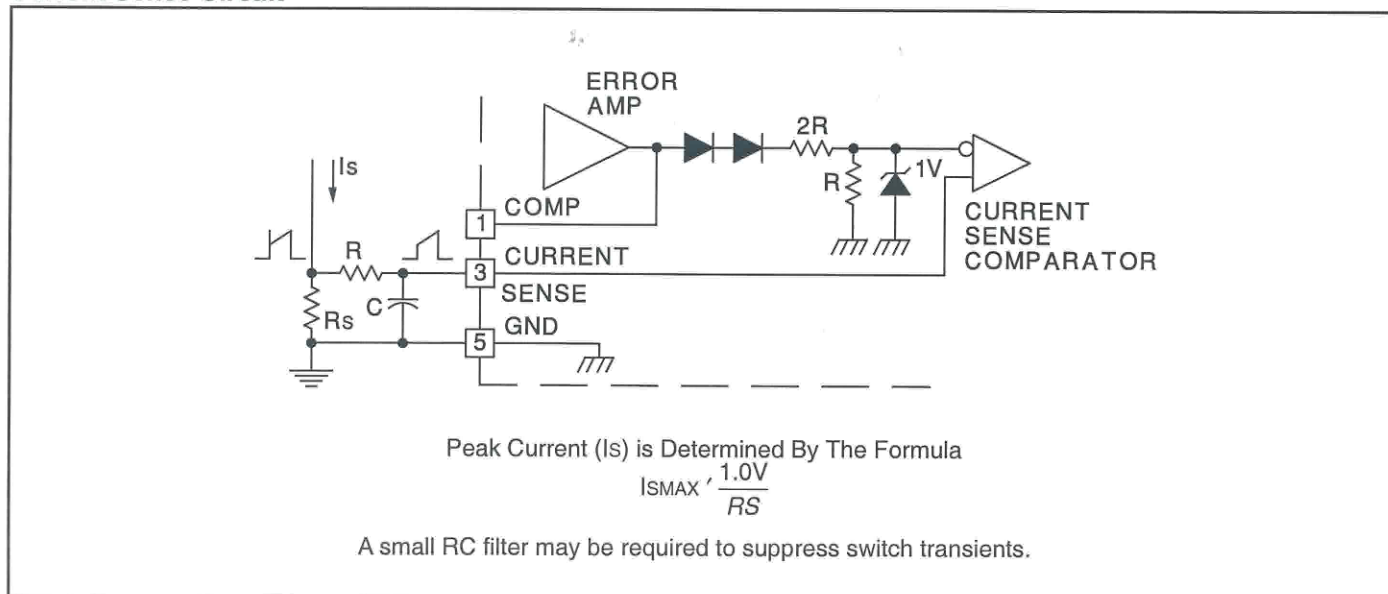


Error Amp can Source and Sink up to 0.5mA, and Sink up to 2mA.

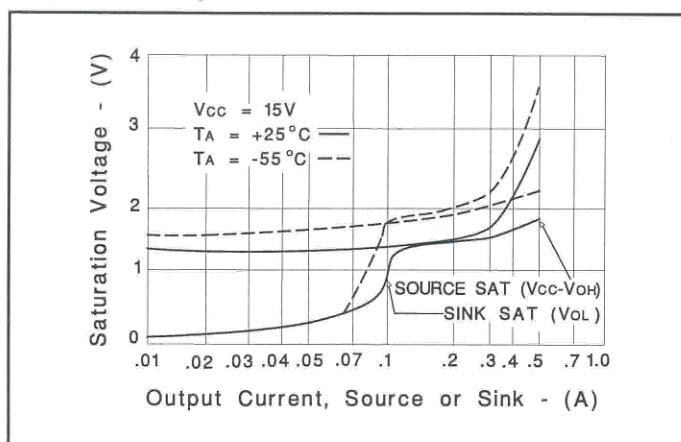
## Under-Voltage Lockout



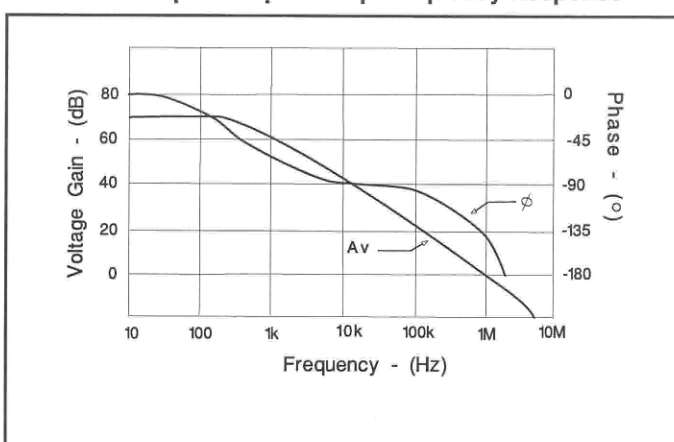
## Current Sense Circuit



## Output Saturation Characteristics

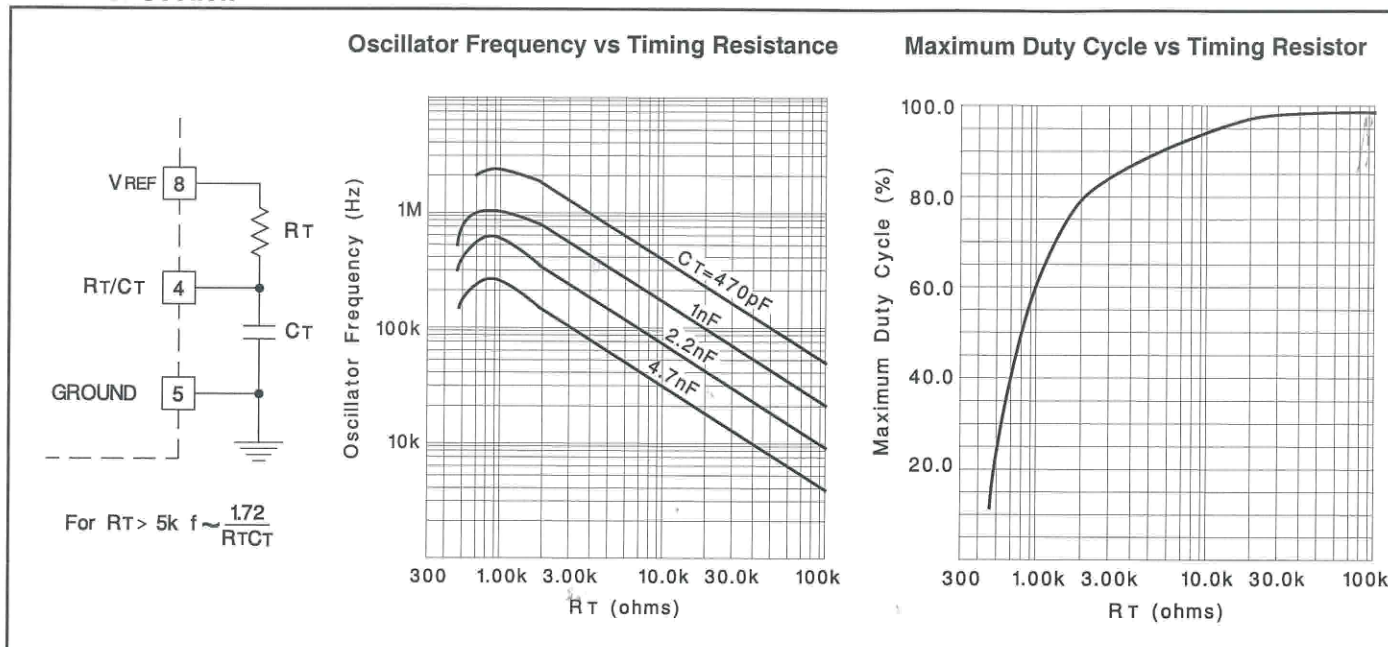


## Error Amplifier Open-Loop Frequency Response

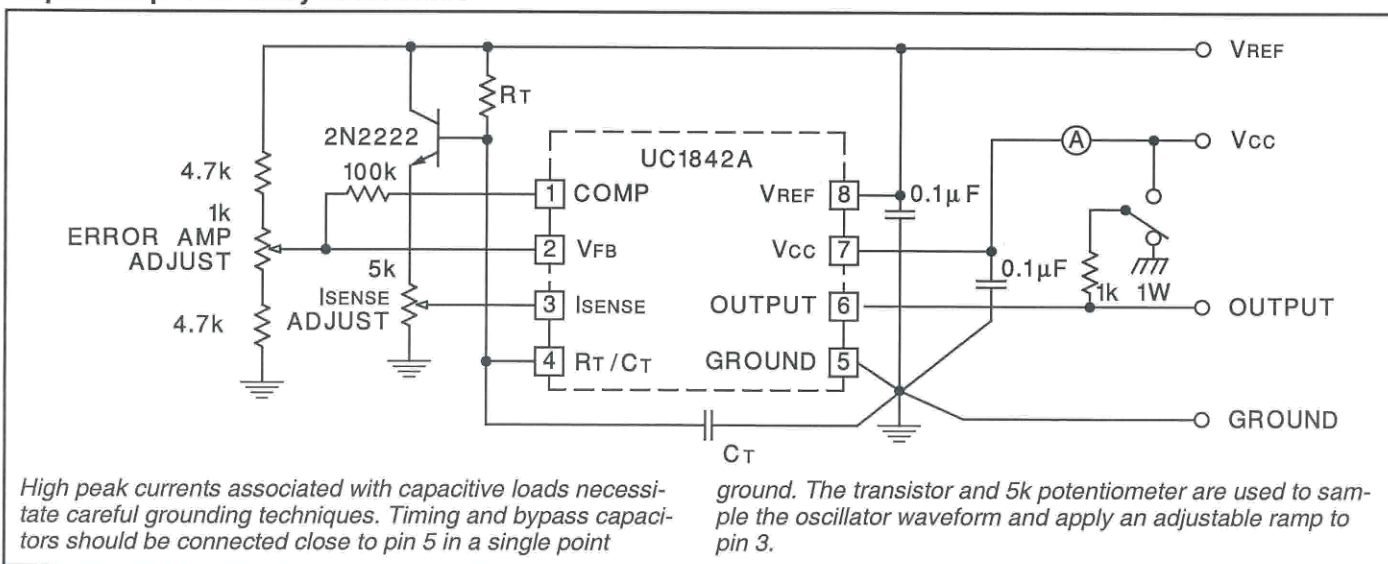


## APPLICATIONS DATA (cont.)

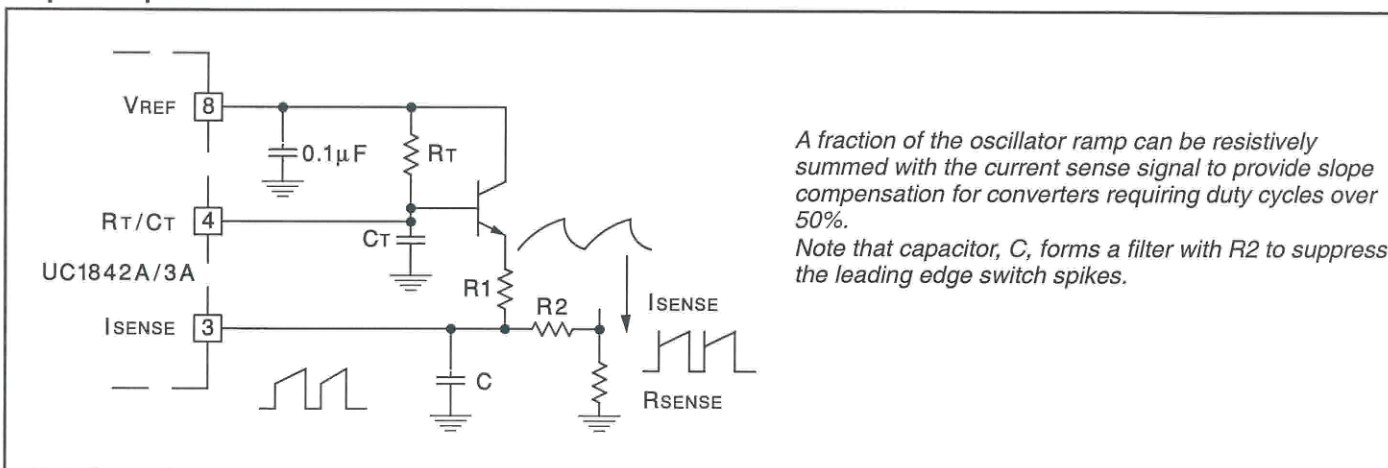
### Oscillator Section



### Open-Loop Laboratory Test Fixture

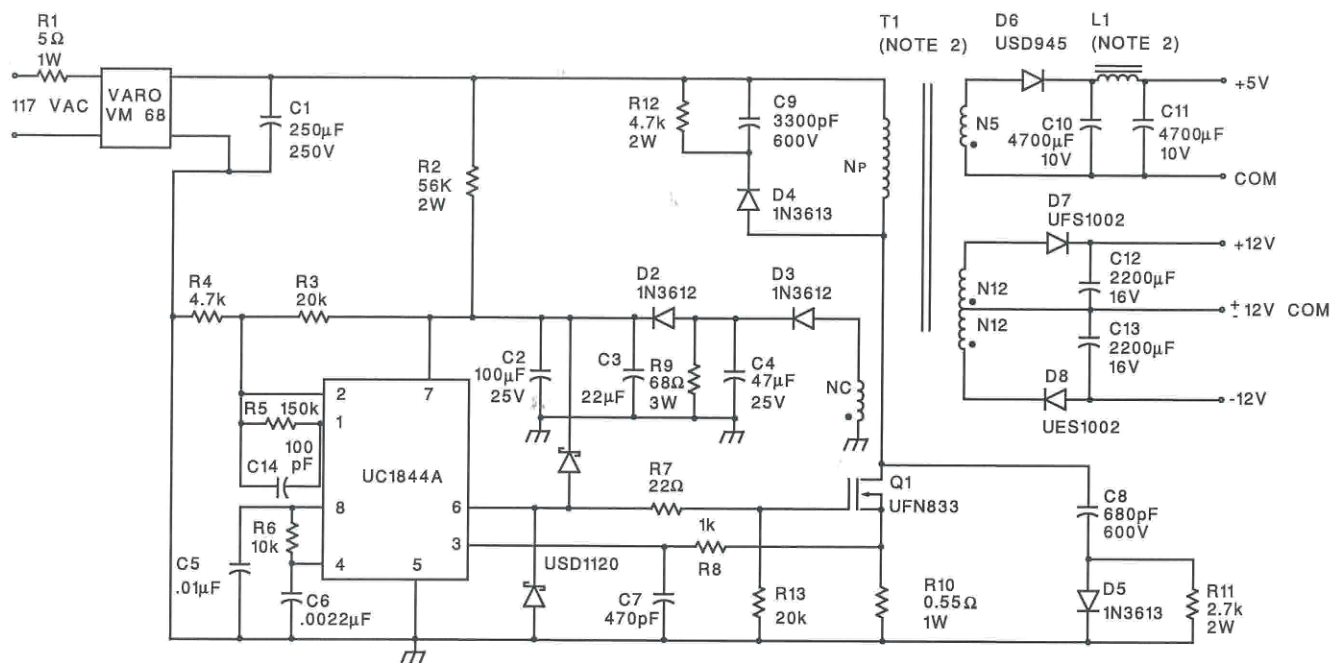


### Slope Compensation



## APPLICATIONS DATA (cont.)

### Off-line Flyback Regulator



#### Power Supply Specifications

- |                         |                                |
|-------------------------|--------------------------------|
| 1. Input Voltage        | 95VAC to 130VA<br>(50 Hz/60Hz) |
| 2. Line Isolation       | 3750V                          |
| 3. Switching Frequency  | 40kHz                          |
| 4. Efficiency Full Load | 70%                            |

#### 5. Output Voltage:

- |                                 |                               |
|---------------------------------|-------------------------------|
| A. +5V, ±5%; 1A to 4A load      | Ripple voltage: 50mV P-P Max  |
| B. +12V, ±3%; 0.1A to 0.3A load | Ripple voltage: 100mV P-P Max |
| C. -12V, ±3%; 0.1A to 0.3A load | Ripple voltage: 100mV P-P Max |

## REVISION HISTORY

Revision B (September 2009) to revision C (August 2010):

Corrected  $I_{SINK}$  voltage, page 4, 15 V to 1.5 V in two places.

Revision C (August 2010 to revision D (July 2011):

Updated Abs Max Table with Max negative voltage and GND pin notes.

**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup>    | Lead/<br>Ball Finish | MSL Peak Temp <sup>(3)</sup> | Samples<br>(Requires Login) |
|------------------|-----------------------|--------------|-----------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| 5962-8670405PA   | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                        | Call TI              | Call TI                      |                             |
| 5962-8670405XA   | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                        | Call TI              | Call TI                      |                             |
| 5962-8670406PA   | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                        | Call TI              | Call TI                      |                             |
| 5962-8670406XA   | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                        | Call TI              | Call TI                      |                             |
| 5962-8670407PA   | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                        | Call TI              | Call TI                      |                             |
| 5962-8670407XA   | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                        | Call TI              | Call TI                      |                             |
| 5962-8670408PA   | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                        | Call TI              | Call TI                      |                             |
| 5962-8670408XA   | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                        | Call TI              | Call TI                      |                             |
| UC1842AJ         | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                        | A42                  | N / A for Pkg Type           |                             |
| UC1842AJ883B     | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                        | A42                  | N / A for Pkg Type           |                             |
| UC1842AL883B     | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                        | POST-PLATE           | N / A for Pkg Type           |                             |
| UC1843AJ         | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                        | A42                  | N / A for Pkg Type           |                             |
| UC1843AJ883B     | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                        | A42                  | N / A for Pkg Type           |                             |
| UC1843AL883B     | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                        | POST-PLATE           | N / A for Pkg Type           |                             |
| UC1844AJ         | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                        | A42                  | N / A for Pkg Type           |                             |
| UC1844AJ883B     | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                        | A42                  | N / A for Pkg Type           |                             |
| UC1844AL883B     | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                        | POST-PLATE           | N / A for Pkg Type           |                             |
| UC1845AJ         | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                        | A42                  | N / A for Pkg Type           |                             |
| UC1845AJ883B     | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                        | A42                  | N / A for Pkg Type           |                             |
| UC1845AL883B     | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                        | POST-PLATE           | N / A for Pkg Type           |                             |
| UC2842AD         | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2842AD8        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2842AD8G4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2842AD8TR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2842AD8TRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup>    | Lead/<br>Ball Finish | MSL Peak Temp <sup>(3)</sup> | Samples<br>(Requires Login) |
|------------------|-----------------------|--------------|-----------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| UC2842ADG4       | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2842ADTR       | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2842ADTRG4     | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2842ADW        | ACTIVE                | SOIC         | DW              | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-2-260C-1 YEAR          |                             |
| UC2842ADWG4      | ACTIVE                | SOIC         | DW              | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-2-260C-1 YEAR          |                             |
| UC2842ADWTR      | ACTIVE                | SOIC         | DW              | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-2-260C-1 YEAR          |                             |
| UC2842ADWTRG4    | ACTIVE                | SOIC         | DW              | 16   | 2000        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-2-260C-1 YEAR          |                             |
| UC2842AJ         | OBSOLETE              | CDIP         | JG              | 8    |             | TBD                        | Call TI              | Call TI                      |                             |
| UC2842AN         | ACTIVE                | PDIP         | P               | 8    | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | N / A for Pkg Type           |                             |
| UC2842ANG4       | ACTIVE                | PDIP         | P               | 8    | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | N / A for Pkg Type           |                             |
| UC2843AD         | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2843AD8        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2843AD8G4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2843AD8TR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2843AD8TRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2843ADG4       | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2843ADTR       | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2843ADTRG4     | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2843AJ         | OBSOLETE              | CDIP         | JG              | 8    |             | TBD                        | Call TI              | Call TI                      |                             |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup>    | Lead/<br>Ball Finish | MSL Peak Temp <sup>(3)</sup> | Samples<br>(Requires Login) |
|------------------|-----------------------|--------------|-----------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| UC2843AN         | ACTIVE                | PDIP         | P               | 8    | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | N / A for Pkg Type           |                             |
| UC2843ANG4       | ACTIVE                | PDIP         | P               | 8    | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | N / A for Pkg Type           |                             |
| UC2843AQ         | ACTIVE                | PLCC         | FN              | 20   | 46          | Green (RoHS<br>& no Sb/Br) | CU SN                | Level-2-260C-1 YEAR          |                             |
| UC2843AQG3       | ACTIVE                | PLCC         | FN              | 20   | 46          | Green (RoHS<br>& no Sb/Br) | CU SN                | Level-2-260C-1 YEAR          |                             |
| UC2844AD         | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2844AD8        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2844AD8G4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2844AD8TR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2844AD8TRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2844ADG4       | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2844ADTR       | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2844ADTRG4     | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2844AN         | ACTIVE                | PDIP         | P               | 8    | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | N / A for Pkg Type           |                             |
| UC2844ANG4       | ACTIVE                | PDIP         | P               | 8    | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | N / A for Pkg Type           |                             |
| UC2844AQD        | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2844AQD8       | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2844AQD8R      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2844AQDR       | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup>    | Lead/<br>Ball Finish | MSL Peak Temp <sup>(3)</sup> | Samples<br>(Requires Login) |
|------------------|-----------------------|--------------|-----------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| UC2845AD         | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2845AD8        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2845AD8G4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2845AD8TR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2845AD8TRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2845ADG4       | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2845ADTR       | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2845ADTRG4     | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC2845ADW        | ACTIVE                | SOIC         | DW              | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-2-260C-1 YEAR          |                             |
| UC2845ADWG4      | ACTIVE                | SOIC         | DW              | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-2-260C-1 YEAR          |                             |
| UC2845AN         | ACTIVE                | PDIP         | P               | 8    | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | N / A for Pkg Type           |                             |
| UC2845ANG4       | ACTIVE                | PDIP         | P               | 8    | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | N / A for Pkg Type           |                             |
| UC3842AD         | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3842AD8        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3842AD8G4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3842AD8TR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3842AD8TRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3842ADG4       | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup>    | Lead/<br>Ball Finish | MSL Peak Temp <sup>(3)</sup> | Samples<br>(Requires Login) |
|------------------|-----------------------|--------------|-----------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| UC3842ADTR       | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3842ADTRG4     | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3842ADW        | ACTIVE                | SOIC         | DW              | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-2-260C-1 YEAR          |                             |
| UC3842ADWG4      | ACTIVE                | SOIC         | DW              | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-2-260C-1 YEAR          |                             |
| UC3842AN         | ACTIVE                | PDIP         | P               | 8    | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | N / A for Pkg Type           |                             |
| UC3842ANG4       | ACTIVE                | PDIP         | P               | 8    | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | N / A for Pkg Type           |                             |
| UC3842J          | ACTIVE                | CDIP         | JG              | 8    | 1           | TBD                        | A42                  | N / A for Pkg Type           |                             |
| UC3843AD         | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3843AD8        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3843AD8G4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3843AD8TR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3843AD8TRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3843ADG4       | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3843ADTR       | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3843ADTRG4     | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3843AN         | ACTIVE                | PDIP         | P               | 8    | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | N / A for Pkg Type           |                             |
| UC3843ANG4       | ACTIVE                | PDIP         | P               | 8    | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | N / A for Pkg Type           |                             |
| UC3844AD         | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup>    | Lead/<br>Ball Finish | MSL Peak Temp <sup>(3)</sup> | Samples<br>(Requires Login) |
|------------------|-----------------------|--------------|-----------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| UC3844AD8        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3844AD8G4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3844AD8TR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3844AD8TRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3844ADG4       | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3844ADTR       | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3844ADTRG4     | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3844AN         | ACTIVE                | PDIP         | P               | 8    | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | N / A for Pkg Type           |                             |
| UC3844ANG4       | ACTIVE                | PDIP         | P               | 8    | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | N / A for Pkg Type           |                             |
| UC3845AD         | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3845AD8        | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3845AD8G4      | ACTIVE                | SOIC         | D               | 8    | 75          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3845AD8TR      | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3845AD8TRG4    | ACTIVE                | SOIC         | D               | 8    | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3845ADG4       | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3845ADTR       | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3845ADTRG4     | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| UC3845AN         | ACTIVE                | PDIP         | P               | 8    | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | N / A for Pkg Type           |                             |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup>    | Lead/<br>Ball Finish | MSL Peak Temp <sup>(3)</sup> | Samples<br>(Requires Login) |
|------------------|-----------------------|--------------|-----------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| UC3845ANG4       | ACTIVE                | PDIP         | P               | 8    | 50          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | N / A for Pkg Type           |                             |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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#### OTHER QUALIFIED VERSIONS OF UC1842A, UC1843A, UC1844A, UC1845A, UC2843A, UC3842A, UC3842M, UC3843A, UC3844A, UC3845A :

- Catalog: [UC3842A](#), [UC3843A](#), [UC3844A](#), [UC3845A](#), [UC3842](#), [UC3845AM](#)

- Automotive: [UC2843A-Q1](#)

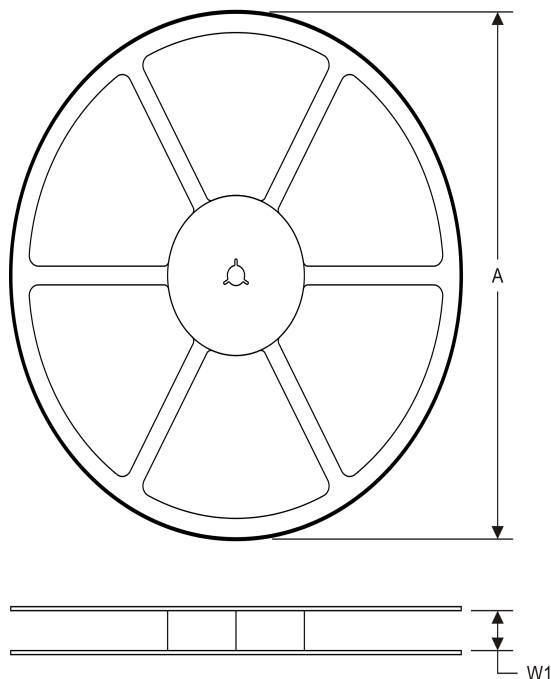
- Enhanced Product: [UC1842A-EP](#), [UC1843A-EP](#), [UC1844A-EP](#), [UC1845A-EP](#), [UC1842A-EP](#), [UC1843A-EP](#), [UC1844A-EP](#), [UC1845A-EP](#)

- Military: [UC1842A](#), [UC1843A](#), [UC1844A](#), [UC1845A](#)

- Space: [UC1842A-SP](#), [UC1843A-SP](#), [UC1844A-SP](#), [UC1845A-SP](#), [UC1842A-SP](#), [UC1843A-SP](#), [UC1844A-SP](#), [UC1845A-SP](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product - Supports Defense, Aerospace and Medical Applications
- Military - QML certified for Military and Defense Applications
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

**TAPE AND REEL INFORMATION**
**REEL DIMENSIONS**

**TAPE DIMENSIONS**

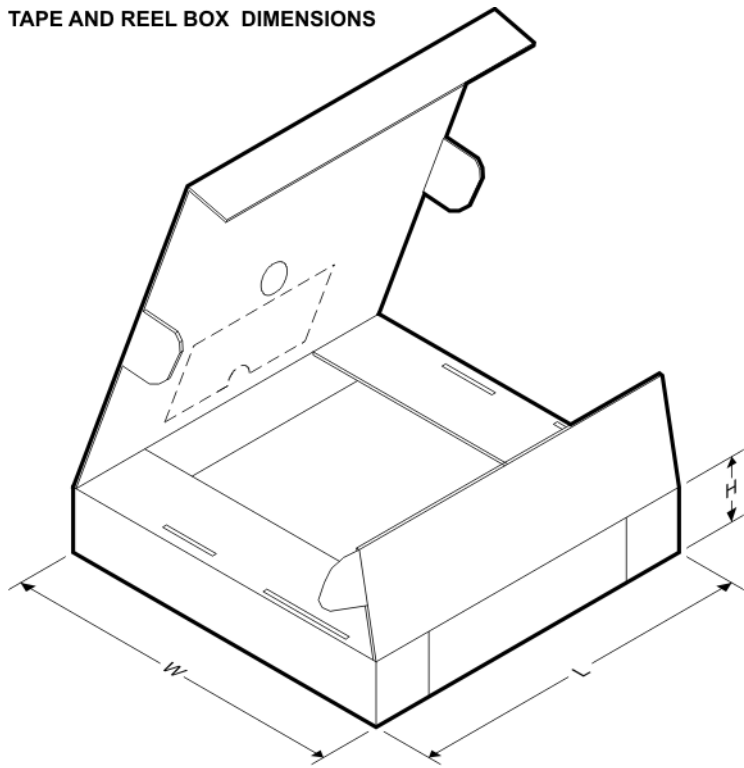

|    |                                                           |
|----|-----------------------------------------------------------|
| A0 | Dimension designed to accommodate the component width     |
| B0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

**TAPE AND REEL INFORMATION**

\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| UC2842AD8TR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| UC2842ADTR  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| UC2842ADWTR | SOIC         | DW              | 16   | 2000 | 330.0              | 16.4               | 10.75   | 10.7    | 2.7     | 12.0    | 16.0   | Q1            |
| UC2843AD8TR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| UC2843ADTR  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| UC2844AD8TR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| UC2844ADTR  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| UC2844AQD8R | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 4.0     | 12.0   | Q1            |
| UC2845AD8TR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| UC2845ADTR  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| UC3842AD8TR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| UC3842ADTR  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| UC3843AD8TR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| UC3843ADTR  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| UC3844AD8TR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| UC3844ADTR  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| UC3845AD8TR | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| UC3845ADTR  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS

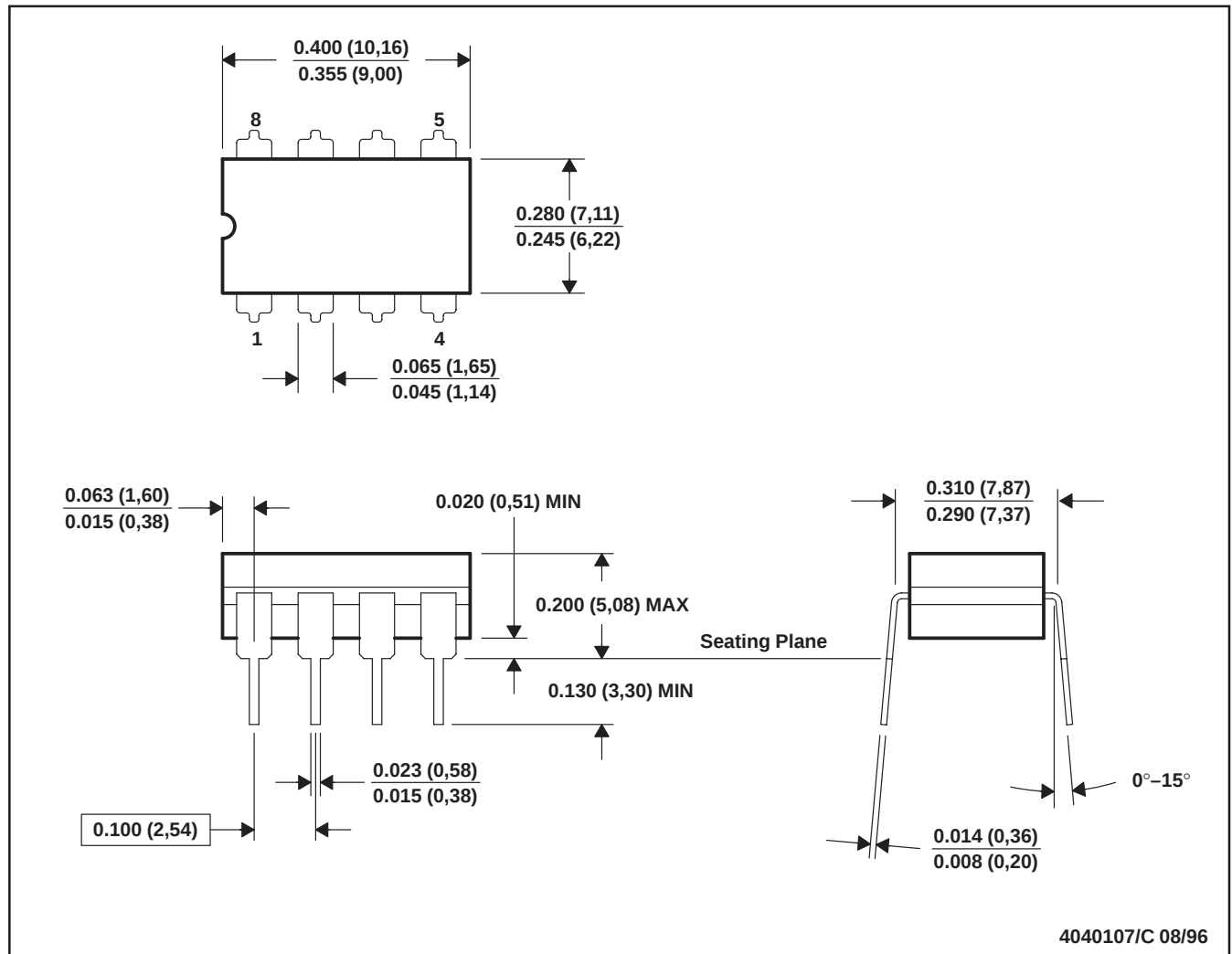


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| UC2842AD8TR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| UC2842ADTR  | SOIC         | D               | 14   | 2500 | 333.2       | 345.9      | 28.6        |
| UC2842ADWTR | SOIC         | DW              | 16   | 2000 | 367.0       | 367.0      | 38.0        |
| UC2843AD8TR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| UC2843ADTR  | SOIC         | D               | 14   | 2500 | 333.2       | 345.9      | 28.6        |
| UC2844AD8TR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| UC2844ADTR  | SOIC         | D               | 14   | 2500 | 333.2       | 345.9      | 28.6        |
| UC2844AQD8R | SOIC         | D               | 8    | 2500 | 367.0       | 367.0      | 35.0        |
| UC2845AD8TR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| UC2845ADTR  | SOIC         | D               | 14   | 2500 | 333.2       | 345.9      | 28.6        |
| UC3842AD8TR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| UC3842ADTR  | SOIC         | D               | 14   | 2500 | 333.2       | 345.9      | 28.6        |
| UC3843AD8TR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| UC3843ADTR  | SOIC         | D               | 14   | 2500 | 333.2       | 345.9      | 28.6        |
| UC3844AD8TR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| UC3844ADTR  | SOIC         | D               | 14   | 2500 | 333.2       | 345.9      | 28.6        |
| UC3845AD8TR | SOIC         | D               | 8    | 2500 | 340.5       | 338.1      | 20.6        |
| UC3845ADTR  | SOIC         | D               | 14   | 2500 | 333.2       | 345.9      | 28.6        |

## JG (R-GDIP-T8)

## CERAMIC DUAL-IN-LINE



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. This package can be hermetically sealed with a ceramic lid using glass frit.  
 D. Index point is provided on cap for terminal identification.  
 E. Falls within MIL STD 1835 GDIP1-T8

FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



| NO. OF<br>TERMINALS<br>** | A                |                  | B                |                  |
|---------------------------|------------------|------------------|------------------|------------------|
|                           | MIN              | MAX              | MIN              | MAX              |
| 20                        | 0.342<br>(8,69)  | 0.358<br>(9,09)  | 0.307<br>(7,80)  | 0.358<br>(9,09)  |
| 28                        | 0.442<br>(11,23) | 0.458<br>(11,63) | 0.406<br>(10,31) | 0.458<br>(11,63) |
| 44                        | 0.640<br>(16,26) | 0.660<br>(16,76) | 0.495<br>(12,58) | 0.560<br>(14,22) |
| 52                        | 0.740<br>(18,78) | 0.761<br>(19,32) | 0.495<br>(12,58) | 0.560<br>(14,22) |
| 68                        | 0.938<br>(23,83) | 0.962<br>(24,43) | 0.850<br>(21,6)  | 0.858<br>(21,8)  |
| 84                        | 1.141<br>(28,99) | 1.165<br>(29,59) | 1.047<br>(26,6)  | 1.063<br>(27,0)  |



4040140/D 01/11

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a metal lid.
  - Falls within JEDEC MS-004

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 variation BA.

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



4040047-5/M 06/11

NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE

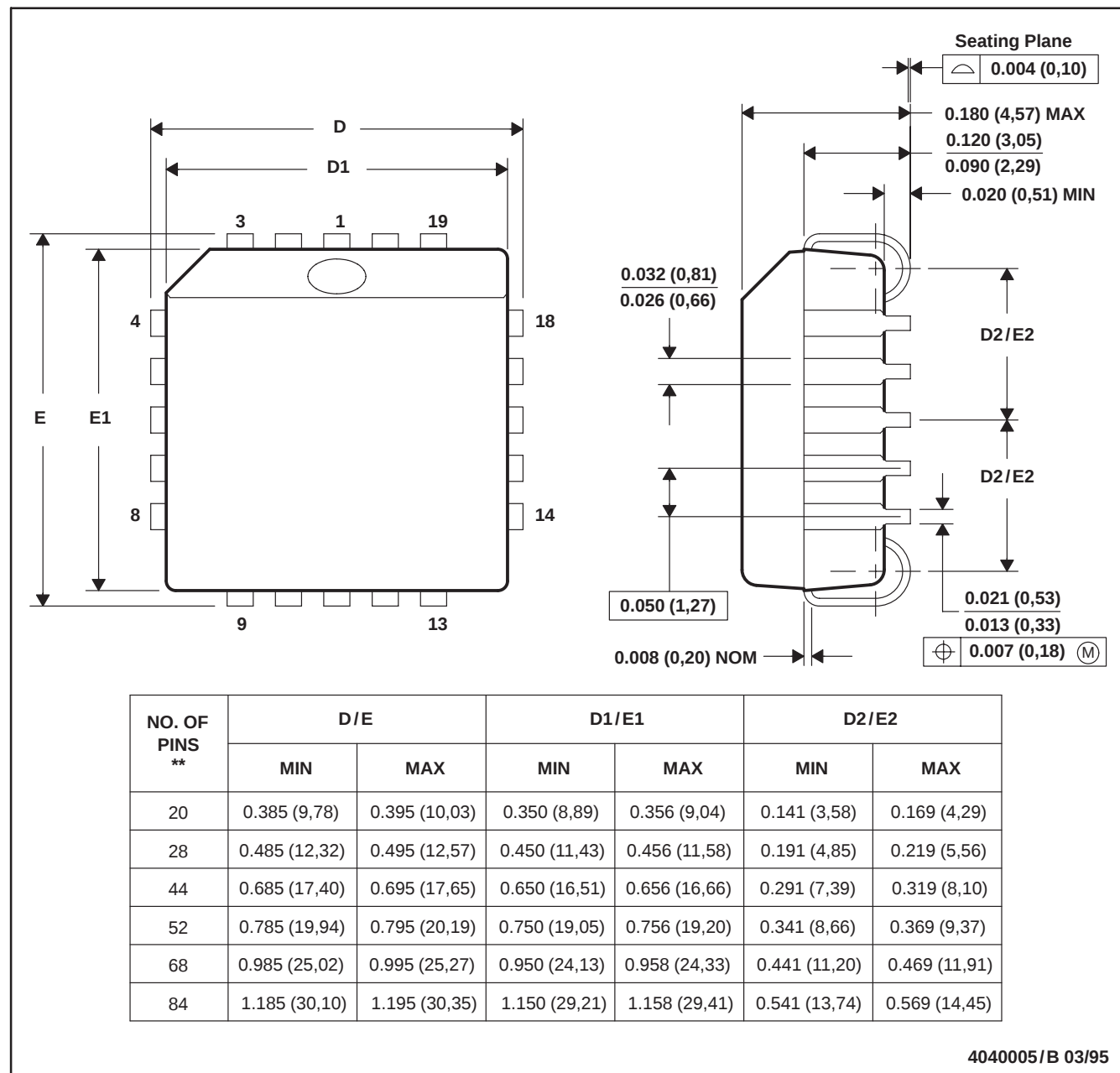


- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

## FN (S-PQCC-J\*\*)

## PLASTIC J-LEADED CHIP CARRIER

20 PIN SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MS-018

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- $\triangle C$  Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- $\triangle D$  Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AA.

D (R-PDSO-G8)

PLASTIC SMALL OUTLINE

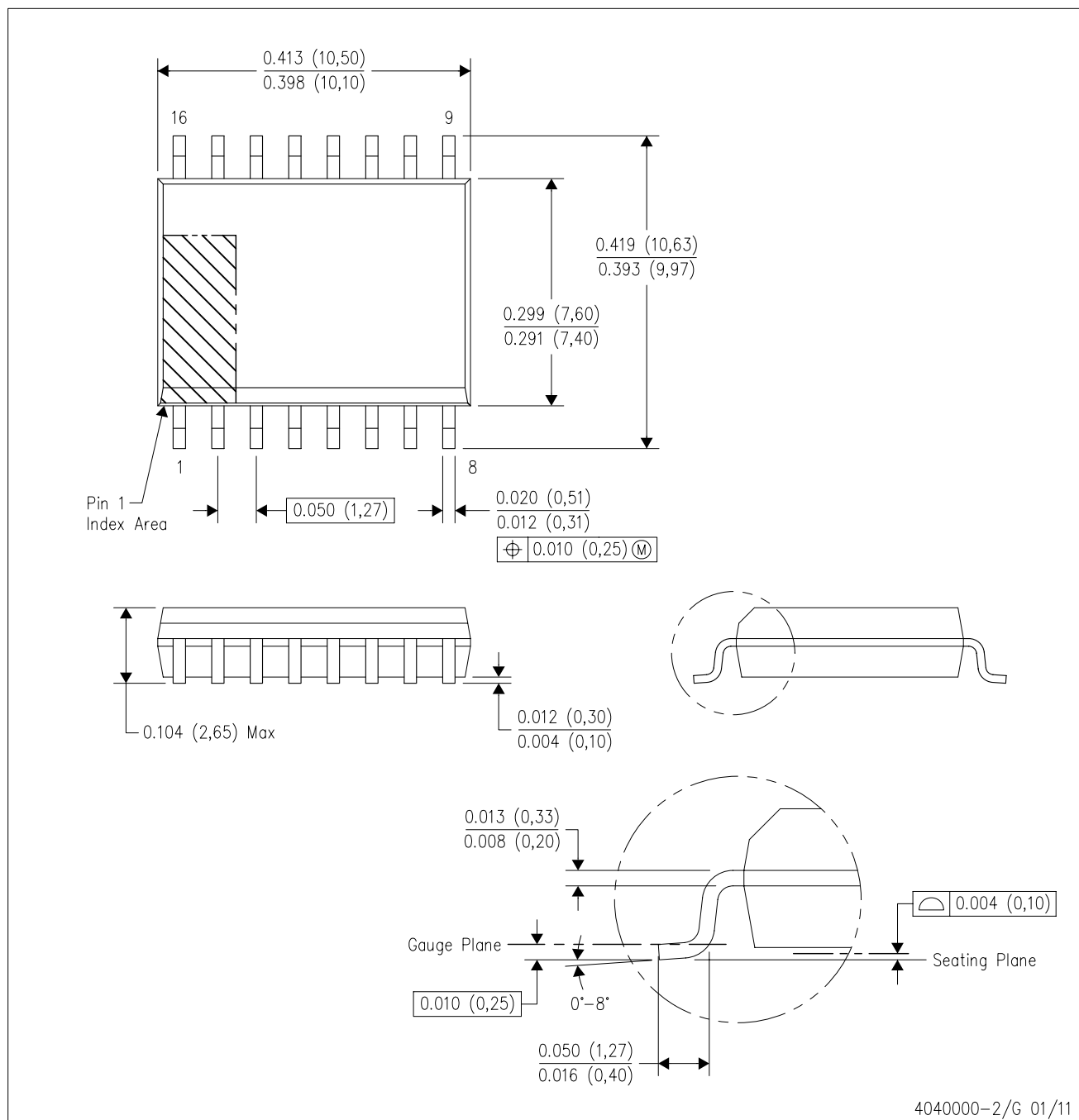


4211283-2/E 08/12

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

DW (R-PDSO-G16)

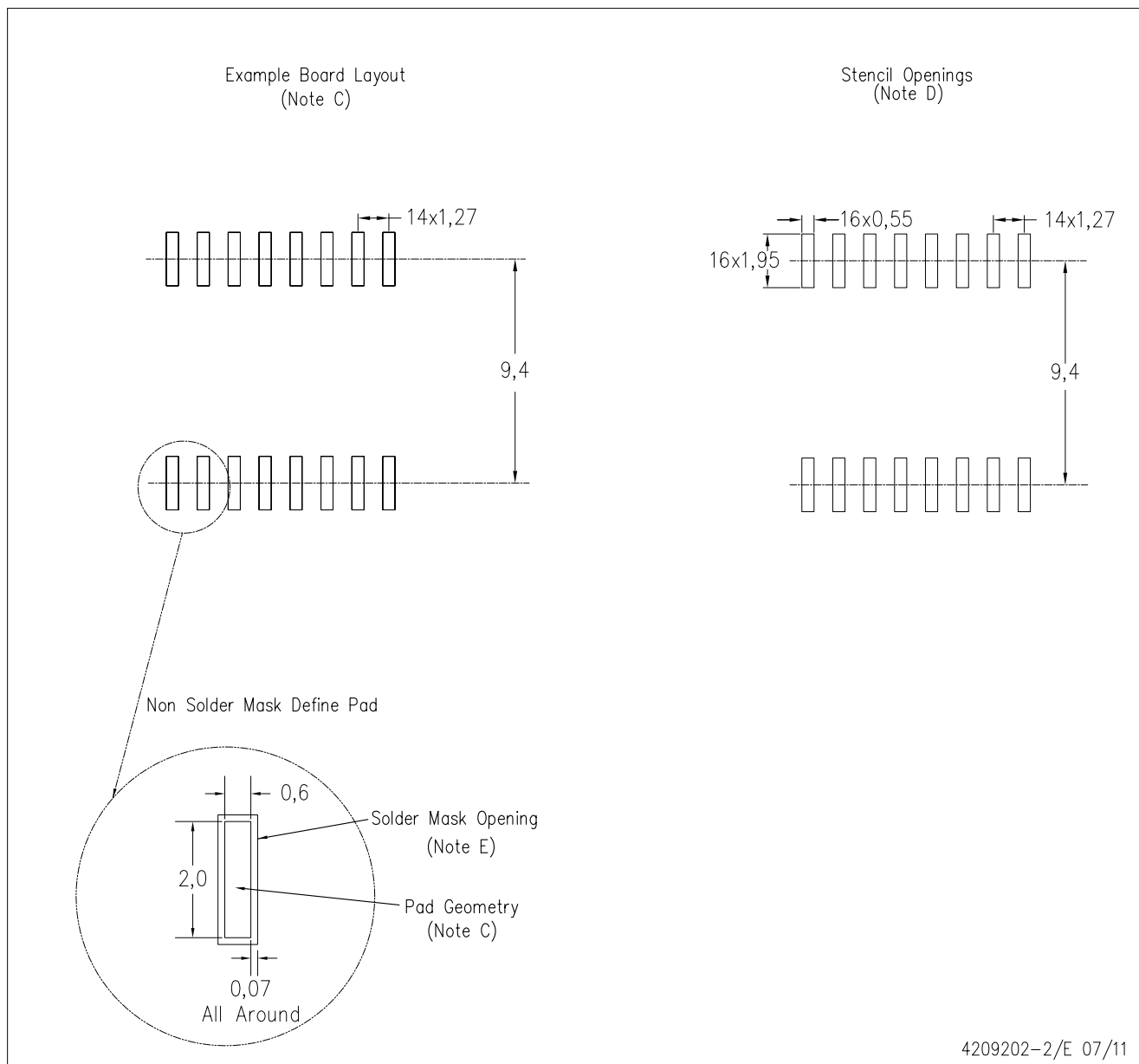
## PLASTIC SMALL OUTLINE



- NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.  
B. This drawing is subject to change without notice.  
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
D. Falls within JEDEC MS-013 variation AA.

DW (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Refer to IPC7351 for alternate board design.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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|                               |                                                                                          |
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